

Amendments to the Claims:

Claims 11-17 are pending in this application. Claim 11 is currently amended. Claims 1-10 and 18-23 were previously canceled. This listing of claims will replace all prior versions, and listings of claims in the application:

Listing of Claims:

1 - 10. (Canceled)

11. (Currently Amended) An input device comprising:

a housing having:

a bottom case having a bottom surface with an alignment groove formed in the bottom surface and extending below the bottom surface, wherein the alignment groove is configured to receive into the alignment groove an alignment protrusion that extends from a surface of a charging base configured to receive the input device for charging the input device, and the alignment groove is substantially triangular to guide the alignment protrusion to the alignment groove as the input device is placed in the charging base;

a top case connected to the bottom case, the top case including a left side grip and a right side grip being formed on a single piece component, the left side grip and the right side grip being configured to be held by a user's thumb on one side and by at least one of the user's ring finger and little finger on another side; and

an upper member connected to the top case and including a palm rest configured to support the user's palm.

12. (Previously Presented) The input device of claim 11 wherein the single piece component includes a front connected between the left side grip and the right side grip.

13. (Previously Presented) The input device of claim 11 wherein at least one of the left side grip and the right side grip has a concave surface.

14. (Previously Presented) The input device of claim 11 wherein a portion of the single piece component has a hollow interior.

15. (Previously Presented) The input device of claim 14 wherein the single piece component having the hollow interior is formed by gas assisted injection molding.

16. (Previously Presented) The input device of claim 11 wherein the single piece component has a thick portion which is thicker than a thin portion, and wherein the thin portion comprises a first material and wherein the thick portion comprises the first material and a second material.

17. (Previously Presented) The input device of claim 16 wherein the single piece component having the thick portion and the thin portion is formed by dual material injection molding.

18 - 23. (Canceled)